



*materials*



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## Materials for LTCC Technology

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Deadline for manuscript  
submissions:

**closed (10 April 2023)**

### Message from the Guest Editor

The Special Issue “Materials for LTCC Technology” will be devoted to new and upgraded functional and auxiliary materials destined for fabrication of multilayer structures, devices and systems using low temperature cofired ceramics (LTCC) technology. Advances in the compositions, preparation methods, processing, characterization methods and electric, thermal, mechanical and magnetic properties of ceramic and glass-ceramic functional materials will be the main subject of the Special Issue. Research and review articles concerning low/ultralow temperature cofired ceramics (LTCC/ULTCC) with low/middle/high dielectric permittivity, low dielectric loss, improved electrical, thermal and mechanical properties, are of particular interest. Papers dealing with new sintering aids, new environment friendly organic systems for tape casting, compatibility of various metallic materials and cosintering ability of heterogeneous green tapes also will be welcome.



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**Special** issue



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## Message from the Editor-in-Chief

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